

# SINGLE AND DUAL FUNCTION HOT PLATES



**Standard Model:** GF-DL dual hot plate  
**Lead Free Model:** GF-DL-HT

Used for a variety of heating applications which include preheat, rework, reflow and curing of printed circuit board assemblies.

**Standard Model:** GF-SL single hot plate  
**Lead Free Model:** GF-SL-HT



## Features:

- Lead free capable option: HT model
- Large 13" x 13" heating area
- 3/4" thick aluminium heat plates for precise, even heating
- Programmable digital temperature controller precisely and automatically regulates temperatures
- Model GF-DL is the same as GF-SL above but with two independent temperature controls and dual 13" x 6.4" plates.

SPECIFICATIONS	GF-DL	GF-SL
Electrical Power**	110 VAC, 50/60, 20A	110 VAC, 50/60
Power	900 W each plate	1800 W
Temperature Range Standard	100° to 482°F (37° to 250°C)	100° to 482°F (37° to 250°C)
Temperature Range High Temp	100° to 600°F (37° to 315°C)	100° to 600°F (37° to 315°C)
Heating Area (x2)	13" x 6.4" (330x163 mm)	13" x 13" (330x330 mm)
Dimensions	22.63" x 15.25" x 4.50" (575 x 387 x 114 mm)	22.63" x 15.25" x 4.50" (575 x 387 x 114 mm)
Approximate Weight	35 lbs (16 Kg)	35 lbs (16 Kg)

\*For use with lead free solder alloys.